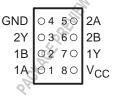
- Available in the Texas Instruments
 NanoStar[™] and NanoFree[™] Packages
- Optimized for 1.8-V Operation and Is 3.6-V I/O Tolerant to Support Mixed-Mode Signal Operation
- I_{off} Supports Partial-Power-Down Mode Operation
- Sub 1-V Operable
- Max t_{pd} of 1.7 ns at 1.8 V
- Low Power Consumption, 10-μA Max I_{CC}
- ±8-mA Output Drive at 1.8 V
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

1A 1 8 V_{CC} 1B 2 7 1Y 2Y 3 6 2B GND 4 5 2A

YEP OR YZP PACKAGE (BOTTOM VIEW)



description/ordering information

This dual 2-input exclusive-OR gate is operational at 0.8-V to 2.7-V V_{CC} , but is designed specifically for 1.65-V to 1.95-V V_{CC} operation.

The SN74AUC2G86 performs the Boolean function $Y = A \oplus B$ or $Y = \overline{A}B + A\overline{B}$ in positive logic.

A common application is as a true/complement element. If the input is low, the other input is reproduced in true form at the output. If the input is high, the signal on the other input is reproduced inverted at the output.

ORDERING INFORMATION

TA	PACKAGEŤ	ORDERABLE PART NUMBER	TOP-SIDE MARKING‡	
	NanoStar™ – WCSP (DSBGA) 0.23-mm Large Bump – YEP	Tape and reel	SN74AUC2G86YEPR	UH
-40°C to 85°C	NanoFree™ – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb-free)	таре апи теег	SN74AUC2G86YZPR	0H_
	SSOP - DCT	Tape and reel	SN74AUC2G86DCTR	U86
	VSSOP - DCU	Tape and reel	SN74AUC2G86DCUR	U86_

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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[‡] DCT: The actual top-side marking has three additional characters that designate the year, month, and assembly/test site. DCU: The actual top-side marking has one additional character that designates the assembly/test site. YEP/YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site.

description/ordering information (continued)

NanoStar™ and NanoFree™ package technology is a major breakthrough in IC packaging concepts, using the die as the package.

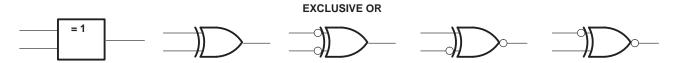
This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

FUNCTION TABLE (each gate)

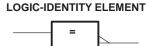
INP	UTS	OUTPUT			
Α	В	Υ			
L	L	L			
L	Н	Н			
Н	L	Н			
Н	Н	L			

exclusive-OR logic

An exclusive-OR gate has many applications, some of which can be represented better by alternative logic symbols.

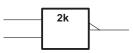


These are five equivalent exclusive-OR symbols valid for an SN74AUC2G86 gate in positive logic; negation may be shown at any two ports.



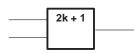
The output is active (low) if all inputs stand at the same logic level (i.e., A = B).

EVEN-PARITY ELEMENT



The output is active (low) if an even number of inputs (i.e., 0 or 2) are active.

ODD-PARITY ELEMENT



The output is active (high) if an odd number of inputs (i.e., only 1 of the 2) are active.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}		0.5 V to 3.6 V
Input voltage range, V _I (see Note 1)		0.5 V to 3.6 V
Voltage range applied to any output in the high	-impedance or power-off state, VO	
(see Note 1)		0.5 V to 3.6 V
Output voltage range, VO (see Note 1)		$0.5 V$ to $V_{CC} + 0.5 V$
Input clamp current, I_{IK} ($V_I < 0$)		50 mA
Output clamp current, I_{OK} ($V_O < 0$)		–50 mA
Continuous output current, IO		±20 mA
Continuous current through V _{CC} or GND		±100 mA
Package thermal impedance, θ_{JA} (see Note 2)	: DCT package	220°C/W
,	DCU package	
	YEP/YZP package	102°C/W
Storage temperature range, T _{sta}		

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

			MIN	MAX	UNIT
VCC	Supply voltage		0.8	2.7	V
		V _{CC} = 0.8 V	Vcc		
V_{IH}	High-level input voltage	$V_{CC} = 1.1 \text{ V to } 1.95 \text{ V}$	0.65 × V _{CC}		V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		
		V _{CC} = 0.8 V		0	
V_{IL}	Low-level input voltage	$V_{CC} = 1.1 \text{ V to } 1.95 \text{ V}$		$0.35 \times V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.7	
٧ _I	Input voltage	-	0	3.6	V
٧o	Output voltage		0	Vcc	V
	High-level output current	V _{CC} = 0.8 V		-0.7	
		V _{CC} = 1.1 V		-3	mA
IOH		V _{CC} = 1.4 V		- 5	
		V _{CC} = 1.65 V		-8	
		V _{CC} = 2.3 V		-9	
		V _{CC} = 0.8 V		0.7	
		V _{CC} = 1.1 V		3	
I_{OL}	Low-level output current	V _{CC} = 1.4 V		5	mA
		V _{CC} = 1.65 V		8	
		V _{CC} = 2.3 V		9	
Δt/Δν	Input transition rise or fall rate			20	ns/V
TA	Operating free-air temperature		-40	85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PA	RAMETER	TEST CONDITIONS	VCC	MIN	TYP†	MAX	UNIT	
		$I_{OH} = -100 \mu\text{A}$	0.8 V to 2.7 V	V _{CC} -0.1				
		$I_{OH} = -0.7 \text{ mA}$	0.8 V		0.55			
\ \/ a		$I_{OH} = -3 \text{ mA}$	1.1 V	0.8			V	
VOH		$I_{OH} = -5 \text{ mA}$	1.4 V	1			V	
		$I_{OH} = -8 \text{ mA}$	1.65 V	1.2				
		$I_{OH} = -9 \text{ mA}$	2.3 V	1.8				
		I _{OL} = 100 μA	0.8 V to 2.7 V			0.2		
		$I_{OL} = 0.7 \text{ mA}$	0.8 V		0.25]	
\ \/a:		$I_{OL} = 3 \text{ mA}$	1.1 V			0.3	V	
VOL		$I_{OL} = 5 \text{ mA}$	1.4 V			0.4	V	
		I _{OL} = 8 mA	1.65 V			0.45		
		I _{OL} = 9 mA	2.3 V			0.6		
IĮ	A or B inputs	$V_I = V_{CC}$ or GND	0 to 2.7 V			±5	μΑ	
l _{off}		V_I or $V_O = 2.7 V$	0			±10	μΑ	
Icc		$V_I = V_{CC}$ or GND, $I_O = 0$	0.8 V to 2.7 V			10	μΑ	
Ci		$V_I = V_{CC}$ or GND	2.5 V		2.5		pF	

[†] All typical values are at T_A = 25°C.

switching characteristics over recommended operating free-air temperature range, C_L = 15 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 0.8 V	V _{CC} =		V _{CC} =	: 1.5 V 1 V		C = 1.8 0.15 V		V _{CC} =		UNIT
'	(1141 01) (001	TYP	TYP	MIN	MAX	MIN	MAX	MIN	TYP	MAX	MIN	MAX	
^t pd	A or B	Υ	5.3	0.8	3.8	0.5	2.6	0.4	1	1.7	0.3	1.3	ns

switching characteristics over recommended operating free-air temperature range, C_L = 30 pF (unless otherwise noted) (see Figure 1)

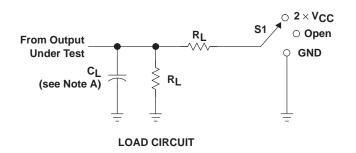
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 1.8 V ± 0.15 V			V _{CC} = 2.5 V ± 0.2 V		UNIT	
	(1141 01)	(0011 01)	MIN	TYP	MAX	MIN	MAX		
^t pd	A or B	Υ	0.8	1.5	2.6	0.7	2	ns	

operating characteristics, T_A = 25°C

PARAMETER		TEST	V _{CC} = 0.8 V	V _{CC} = 1.2 V	V _{CC} = 1.5 V	V _{CC} = 1.8 V	V _{CC} = 2.5 V	UNIT
		CONDITIONS	TYP	TYP TYP TYP		TYP		
C _{pd}	Power dissipation capacitance	f = 10 MHz	15	15	16	19	27	pF

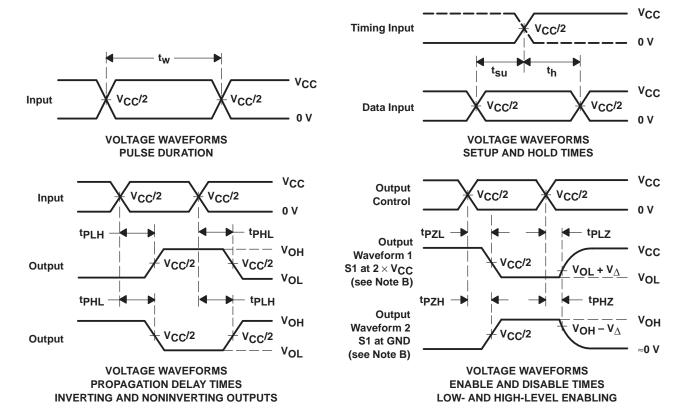


PARAMETER MEASUREMENT INFORMATION



TEST	S1
tPLH/tPHL	Open
tPLZ/tPZL	$2 \times V_{CC}$
tPHZ/tPZH	GND

VCC	CL	RL	v_Δ
0.8 V	15 pF	2 k Ω	0.1 V
1.2 V \pm 0.1 V	15 pF	2 k Ω	0.1 V
1.5 V \pm 0.1 V	15 pF	2 k Ω	0.1 V
1.8 V \pm 0.15 V	15 pF	2 k Ω	0.15 V
2.5 V \pm 0.2 V	15 pF	2 k Ω	0.15 V
1.8 V \pm 0.15 V	30 pF	1 k Ω	0.15 V
2.5 V \pm 0.2 V	30 pF	500 Ω	0.15 V



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.

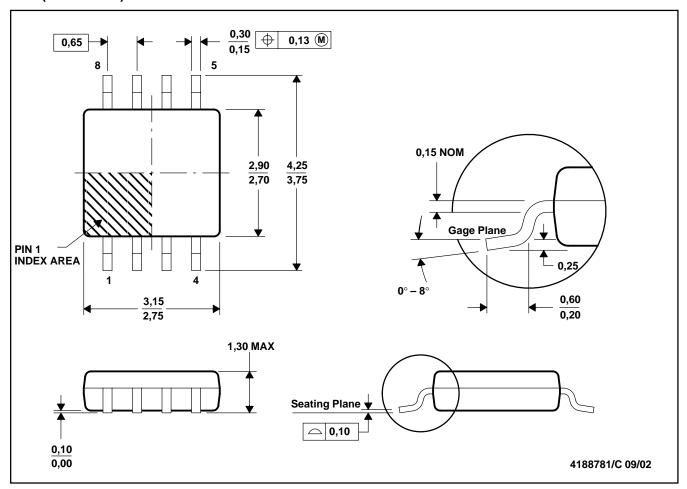
 Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, slew rate \geq 1 V/ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



DCT (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE

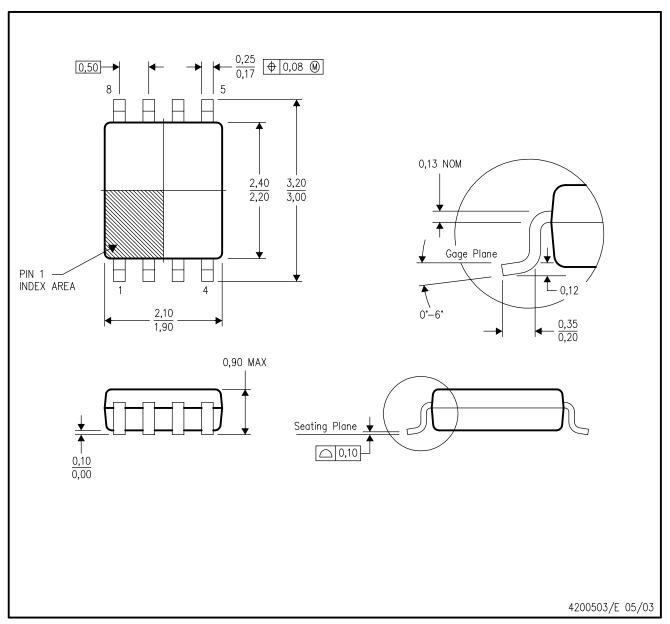


NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion
- D. Falls within JEDEC MO-187 variation DA.

DCU (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE (DIE DOWN)



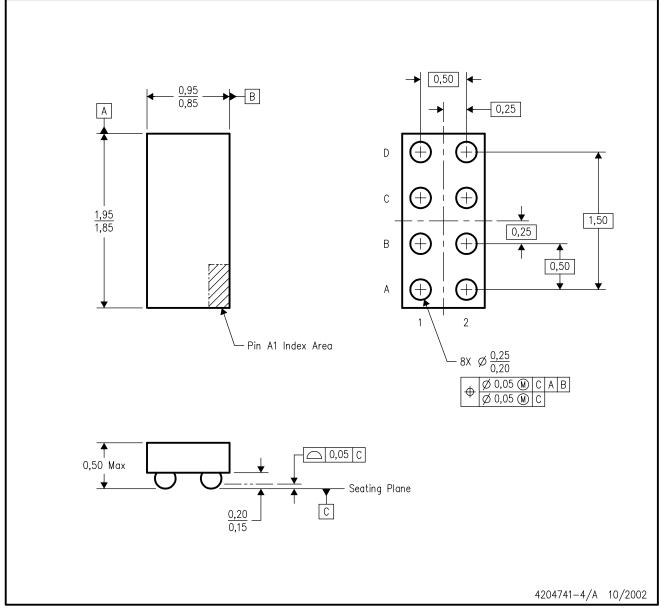
NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.
- D. Falls within JEDEC MO-187 variation CA.



YZP (R-XBGA-N8)

DIE-SIZE BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters.

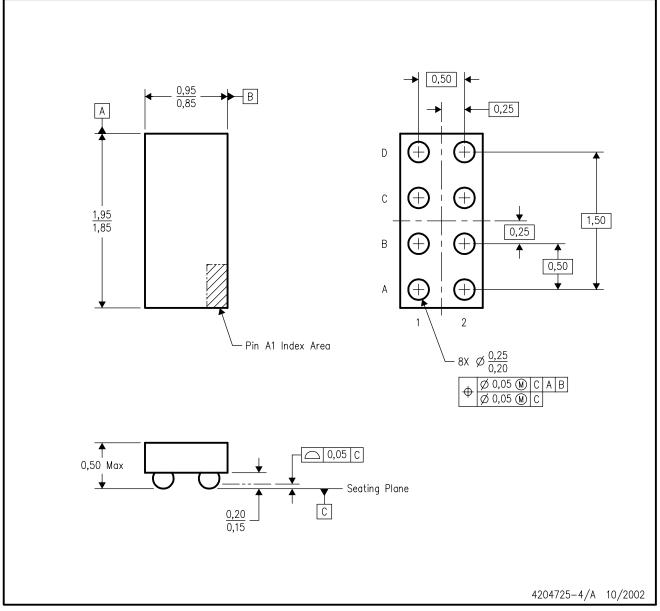
- B. This drawing is subject to change without notice.
- C. NanoFree $^{\text{TM}}$ package configuration.
- D. This package is lead-free. Refer to the 8 YEP package (drawing 4204725) for tin-lead (SnPb).

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YEP (R-XBGA-N8)

DIE-SIZE BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. NanoStar \mathbf{M} package configuration.
- D. This package is tin-lead (SnPb). Refer to the 8 YZP package (drawing 4204741) for lead-free.

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